# Errata

# MSP430AFE253 Microcontroller



#### **ABSTRACT**

This document describes the known exceptions to the functional specifications (advisories).

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# 1 Functional Advisories

Advisories that affect the device's operation, function, or parametrics.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev A
BCL12	✓
FLASH24	✓
FLASH27	✓
FLASH36	✓
TA12	✓
TA16	✓
TA18	✓
TA21	✓
TAB22	✓
US15	✓

# 2 Preprogrammed Software Advisories

Advisories that affect factory-programmed software.

✓ The check mark indicates that the issue is present in the specified revision.

The device does not have any errata for this category.

# 3 Debug Only Advisories

Advisories that affect only debug operation.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev A
EEM20	✓

# 4 Fixed by Compiler Advisories

Advisories that are resolved by compiler workaround. Refer to each advisory for the IDE and compiler versions with a workaround.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev A
CPU4	✓

Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

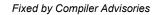
#### TI MSP430 Compiler Tools (Code Composer Studio IDE)

- MSP430 Optimizing C/C++ Compiler: Check the --silicon\_errata option
- MSP430 Assembly Language Tools

#### MSP430 GNU Compiler (MSP430-GCC)

- MSP430 GCC Options: Check -msilicon-errata= and -msilicon-errata-warn= options
- MSP430 GCC User's Guide

#### IAR Embedded Workbench





• IAR workarounds for msp430 hardware issues



# 5 Nomenclature, Package Symbolization, and Revision Identification

The revision of the device can be identified by the revision letter on the Package Markings or by the HW\_ID located inside the TLV structure of the device.

#### **5.1 Device Nomenclature**

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

**XMS** – Experimental device that is not necessarily representative of the final device's electrical specifications

MSP - Fully qualified production device

Support tool naming prefixes:

X: Development-support product that has not yet completed Texas Instruments internal qualification testing.

null: Fully-qualified development-support product.

XMS devices and X development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. Tl's standard warranty applies.

Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format.

### 5.2 Package Markings

**PW24** 

TSSOP (PW), 24 Pin



Die revisionPin 1 location

0

Ν

= Lot trace code

#### 5.3 Memory-Mapped Hardware Revision (TLV Structure)

This device does not support reading the hardware revision from memory.

Further guidance on how to locate the TLV structure and read out the HW\_ID can be found in the device User's Guide.



# **6 Advisory Descriptions**

BCL12 BCL Module

Category Functional

**Function** Switching RSELx or modifying DCOCTL can cause DCO dead time or a complete DCO

stop

**Description** After switching RSELx bits (located in register BCSCTL1) from a value of >13 to a value

of <12 OR from a value of <12 to a value of >13, the resulting clock delivered by the DCO can stop before the new clock frequency is applied. This dead time is approximately 20

us. In some instances, the DCO may completely stop, requiring a power cycle.

Furthermore, if all of the RSELx bits in the BSCTL1 register are set, modifying the DCOCTL register to change the DCOx or the MODx bits could also result in DCO dead

time or DCO hang up.

Workaround

- When switching RSEL from >13 to <12, use an intermediate frequency step. The intermediate RSEL value should be 13.

Current RSEL	Target RSEL	Recommended Transition Sequence
15	14	Switch directly to target RSEL
14 or 15	13	Switch directly to target RSEL
14 or 15	0 to 12	Switch to 13 first, and then to target RSEL (two step sequence)
0 to 13	0 to 12	Switch directly to target RSEL

#### AND

- When switching RSEL from <12 to >13 it's recommended to set RSEL to its default value first (RSEL = 7) before switching to the desired target frequency.

#### AND

- In case RSEL is at 15 (highest setting) it's recommended to set RSEL to its default value first (RSEL = 7) before accessing DCOCTL to modify the DCOx and MODx bits. After the DCOCTL register modification the RSEL bits can be manipulated in an additional step.

In the majority of cases switching directly to intermediate RSEL steps as described above will prevent the occurrence of BCL12. However, a more reliable method can be implemented by changing the RSEL bits step by step in order to guarantee safe function without any dead time of the DCO.

Note that the 3-step clock startup sequence consisting of clearing DCOCTL, loading the BCSCTL1 target value, and finally loading the DCOCTL target value as suggested in the in the "TLV Structure" chapter of the MSP430x2xx Family User's Guide is not affected by BCL12 if (and only if) it is executed after a device reset (PUC) prior to any other modifications being made to BCSCTL1 since in this case RSEL still is at its default value of 7. However any further changes to the DCOx and MODx bits will require the consideration of the workaround outlined above.

CPU4 CPU Module

Category Compiler-Fixed

Function PUSH #4, PUSH #8



**Description** 

The single operand instruction PUSH cannot use the internal constants (CG) 4 and 8. The other internal constants (0, 1, 2, -1) can be used. The number of clock cycles is different:

PUSH #CG uses address mode 00, requiring 3 cycles, 1 word instruction PUSH #4/#8 uses address mode 11, requiring 5 cycles, 2 word instruction

Workaround

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v2.x until v6.20	User is required to add the compiler flag option below hw_workaround=CPU4
IAR Embedded Workbench	IAR EW430 v6.20 or later	Workaround is automatically enabled
TI MSP430 Compiler Tools (Code Composer Studio)	v1.1 or later	
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 167 or later	

EEM20 EEM Module

**Category** Debug

**Function** Debugger might clear interrupt flags

**Description** During debugging read-sensitive interrupt flags might be cleared as soon as the debugger

stops. This is valid in both single-stepping and free run modes.

Workaround None.

FLASH24 FLASH Module

Category

**Functional** 

**Function** 

Write or erase emergency exit can cause failures

**Description** 

When a flash write or erase is abruptly terminated, the following flash accesses by the CPU may be unreliable resulting in erroneous code execution. The abrupt termination can be the result of one the following events:

1) The flash controller clock is configured to be sourced by an external crystal. An oscillator fault occurs thus stopping this clock abruptly.

or

2) The Emergency Exit bit (EMEX in FCTL3) when set forces a write or an erase operation to be terminated before normal completion.

or

3) The Enable Emergency Interrupt Exit bit (EEIEX in FCTL1) when set with GIE=1 can lead to an interrupt causing an emergency exit during a Flash operation.

Workaround

- 1) Use the internal DCO as the flash controller clock provided from MCLK or SMCLK.
- 2) After setting EMEX = 1, wait for a sufficient amount of time before Flash is accessed again.
- 3) No Workaround. Do not use EEIEX bit.

www.ti.com Advisory Descriptions

FLASH27 FLASH Module

**Category** Functional

**Function** EEI feature can disrupt segment erase

**Description** When a flash segment erase operation is active with EEI feature selected (EEI=1 in

FLCTL1) and GIE=0, the following can occur:

An interrupt event causes the flash erase to be stopped, and the flash controller expects an RETI to resume the erase. Because GIE=0, interrupts are not serviced and RETI will

never happen.

Workaround 1) Do not set bit EEI=1 when GIE = 0.

or,

2) Force an RETI instruction during the erase operation during the check for BUSY=1

(FCLTL3).

Sample code:

MOV R5, 0(R5); Dummy write, erase segment LOOP: BIT #BUSY, &FCTL3; test busy bit JMP SUB\_RETI; Force RETI instruction

JNZ LOOP; loop while BUSY=1

SUB RETI: PUSH SR

RETI

FLASH36 FLASH Module

Category Functional

**Function** Flash content may degrade due to aborted page erases

**Description** If a page erase is aborted by EEIEX, the flash page containing the last instruction before

erase operation will start to degrade. This effect is incremental and, after repetitions, may

lead to corrupted flash content.

**Workaround** - Use the EEI (interrupted erasing) feature instead of EEIEX (abort erasing).

or

- A PSA checksum can be calculated over affected flash page using the marginal read mode (marginal 0). If PSA sum differs from expected PSA value the affected flash page

has to be reprogrammed.

or

- Start flash erasing from RAM and limit system frequency to <1MHz (to ensure 6-us delay after EEIEX). If the last instruction before erasing is located in RAM, flash cell degradation

does not occur.

TA12 TA Module

Category Functional

Function Interrupt is lost (slow ACLK)

**Description** Timer\_A counter is running with slow clock (external TACLK or ACLK)compared to MCLK.

The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer A



counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer A counter increment (if TAR = CCRx + 1). This interrupt gets

Workaround Switch capture/compare mode to capture mode before the CCRx register increment.

Switch back to compare mode afterwards.

TA Module **TA16** 

Category **Functional** 

**Function** First increment of TAR erroneous when IDx > 00

Description The first increment of TAR after any timer clear event (POR/TACLR) happens immediately

> following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following

TAR increments are performed correctly with the selected IDx settings.

Workaround None

**TA Module TA18** 

Category Functional

**Function** MOV to TACTL may clear TAR

**Description** When TACTL is modified with a MOV instruction, the contents of TAR may be cleared,

even when TACLR is not set.

Workaround Use BIS or BIC instructions to modify TACTL.

Note

A DMA transfer must not occur while these BIS and BIC instructions execute. This can be prevented by disabling the DMA prior to these instructions, or by using the DMAONFETCH bit to align DMA transfers to instruction fetch boundaries.

**TA Module TA21** 

Category **Functional** 

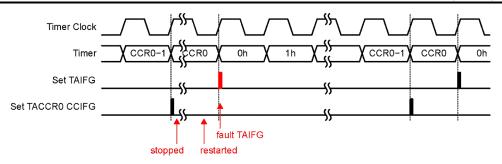
**Function** TAIFG Flag is erroneously set after Timer A restarts in Up Mode

**Description** In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to

> zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the TACLK

will erroneously set the TAIFG flag.





Workaround None.

TAB22 TAB Module

**Category** Functional

Function Timer A/Timer B register modification after Watchdog Timer PUC

**Description** Unwanted modification of the Timer\_A/Timer\_B registers TACTL/TBCTL and TAIV/TBIV

can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer\_A/Timer\_B counter register TACCRx/TBCCRx is incremented/

decremented (Timer\_A/Timer\_B does not need to be running).

Workaround Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC

may not fully initialize the register). TAIV/TBIV is automatically cleared following this

initialization.

Example code:

MOV.W #VAL, &TACTL

or

MOV.W #VAL, &TBCTL

Where, VAL=0, if Timer is not used in application otherwise, user defined per desired

function.

US15 USART Module

**Category** Functional

**Function** UART receive with two stop bits

**Description** USART hardware does not detect a missing second stop bit when SPB = 1.

The Framing Error Flag (FE) will not be set under this condition and erroneous data

reception may occur.

**Workaround** None (Configure USART for a single stop bit, SPB = 0)

Revision History www.ti.com

**7 Revision History**NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

CI	nanges from May 29, 2018 to May 11, 2021	Page
•	Changed the document format and structure; updated the numbering format for tables, figures, and cro	SS
	references throughout the document	5
•	PW24 was updated	5
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